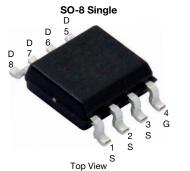
Si4116DY

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Vishay Siliconix



PRODUCT SUMMARY					
V _{DS} (V)	25				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.0086				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.0095				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 2.5 V	0.0115				
Q _g typ. (nC)	17.5				
I _D (A) ^a	18				
Configuration	Single				

FEATURES

N-Channel 25 V (D-S) MOSFET

- TrenchFET® power MOSFET
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

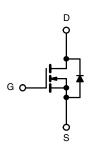
APPLICATIONS

Synchronous buck
Low side



HALOGEN

FREE



N-Channel MOSFET

ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free	Si4116DY-T1-E3			
Lead (Pb)-free and halogen-free	Si4116DY-T1-GE3			

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	25	V	
Gate-source voltage		V _{GS}	± 12	V	
	T _C = 25 °C		18		
Continuous dusin surrent (T 150 °C)	T _C = 70 °C	Ι. Γ	14.3		
Continuous drain current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C		12.7 ^{b, c}		
	T _A = 70 °C		10.1 ^{b, c}	•	
Pulsed drain current		I _{DM}	50	A	
Continuous source-drain diode current	T _C = 25 °C		4.5		
	T _A = 25 °C	I _S	2.2 ^{b, c}		
Single pulse avalanche current	nt L = 0.1 mH		20		
Avalanche energy	L = 0.1 mH	E _{AS}	20	mJ	
Maximum power dissipation	T _C = 25 °C		5		
	T _C = 70 °C		3.2	w	
	T _A = 25 °C	P _D	2.5 ^{b, c}	vv	
	T _A = 70 °C		1.6 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, d	$t \le 10 s$	R _{thJA}	43	50	°C/W	
Maximum junction-to-foot (drain)	Steady state	R _{thJF}	19	25	C/W	

Notes

a. Based on $T_C = 25 \ ^{\circ}C$

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. Maximum under steady state conditions is 95 $^\circ\text{C/W}$

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Si4116	DY
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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	25	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_J$		-	30	-	mV/°C	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-4	-		
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.6	-	1.4	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$	-	-	± 100	nA	
		$V_{DS} = 25 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	μA	
Zero gate voltage drain current	IDSS	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	-	-	10		
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 V$, $V_{GS} = 10 V$	30	-	-	Α	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	0.0071	0.0086		
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 7 \text{ A}$	-	0.0078	0.0095	Ω	
		$V_{GS} = 2.5 \text{ V}, I_D = 5 \text{ A}$	-	0.0090	0.0115		
Forward transconductance a	g _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	68	-	S	
Dynamic ^b			•				
Input capacitance	C _{iss}		-	1925	-		
Output capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	305	-	pF	
Reverse transfer capacitance	C _{rss}		-	135	-		
		$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	37	56		
Total gate charge	Qg		-	17.5	27	-	
Gate-source charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$	-	3.7	-	nC	
Gate-drain charge	Q _{gd}		-	3.3	-		
Gate resistance	R _g	f = 1 MHz	-	1.6	3	Ω	
Turn-on delay time	t _{d(on)}		-	13	25		
Rise time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{I}} = 1.5 \Omega$	-	11	20		
Turn-off delay time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{\text{GEN}} = 4.5 \text{ V}, R_g = 1 \Omega$	-	50	90		
Fall time	t _f		-	15	30		
Turn-on delay time	t _{d(on)}		-	7	14	ns	
Rise time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω	-	10	20		
Turn-off delay time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{\text{GEN}} = 10 \text{ V}, R_g = 1 \Omega$	_	31	55		
Fall time	t _f		_	9	18		
Drain-Source Body Diode Characterist	cs				1		
Continuous source-drain diode current	Is	T _C = 25 °C	-	-	4.5		
Pulse diode forward current ^a	I _{SM}			-	50	A	
Body diode voltage	V _{SD}	I _S = 3 A	-	0.69	1.1	V	
Body diode reverse recovery time	t _{rr}		-	26	45	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = 5 A, di/dt = 100 A/μs,	-	16	30	nC	
Reverse recovery fall time	t _a	$T_J = 25 \text{ °C}$	-	13	-		
Reverse recovery rise time	t _b		_	13	_	ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

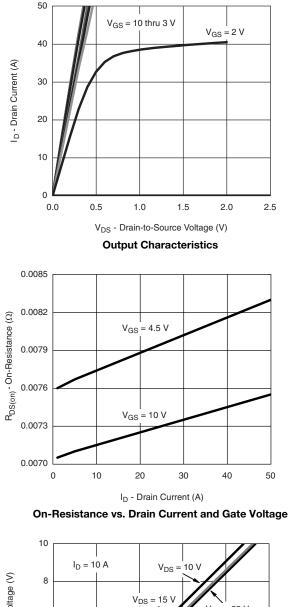
b. Guaranteed by design, not subject to production testing

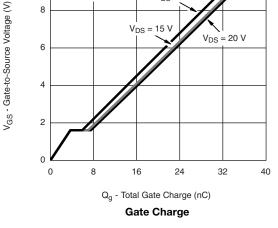
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

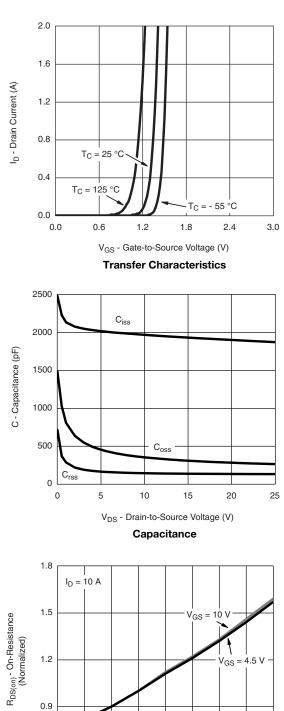
2



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







0.6 - 50 - 25 0 25 50 75 100 125 150 T_J - Junction Temperature (°C)

On-Resistance vs. Junction Temperature

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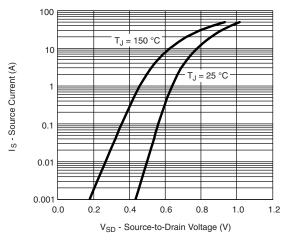
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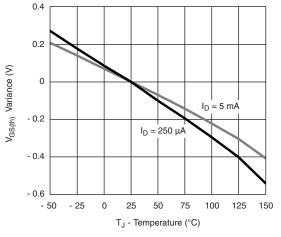
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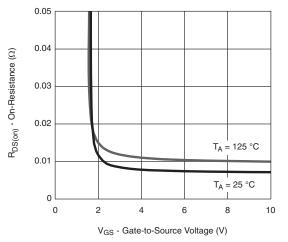
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



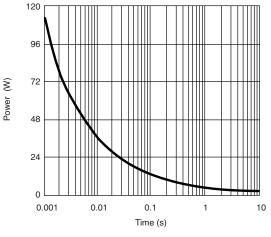
Source-Drain Diode Forward Voltage



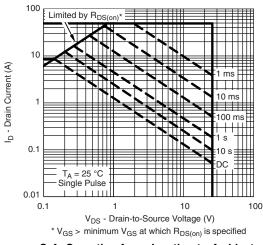
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



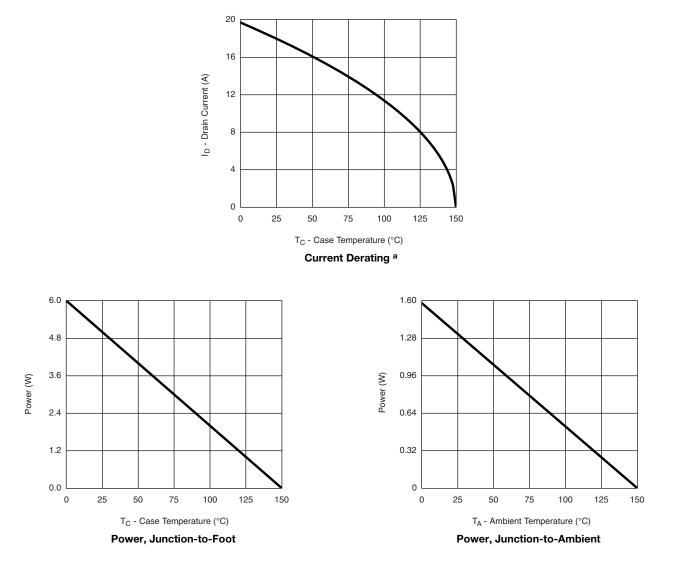
Safe Operating Area, Junction-to-Ambient

4

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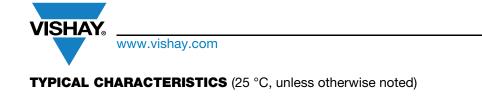


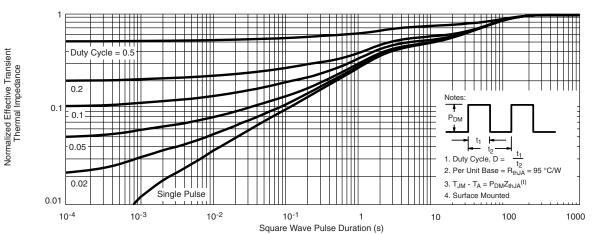
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



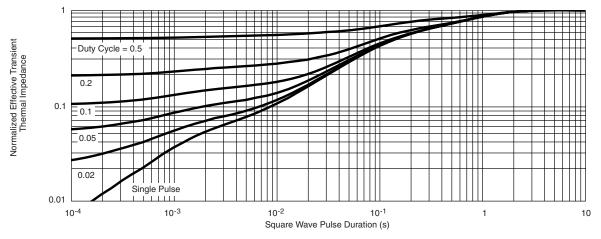
Note

a. The power dissipation P_D is based on T_J max = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?69837.

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Vishay Siliconix



Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIMETERS		INC	INCHES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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